

Power Supply Input

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
VACMIN	85	V	Minimum Input AC Voltage
VACMAX	265	V	Maximum Input AC Voltage
FL	50	Hz	Line Frequency
TC	2.69	ms	Diode Conduction Time
Z	0.70		Loss Allocation Factor
η	71.0	%	Efficiency Estimate
VMIN	96.5	V	Minimum DC Input Voltage
VMAX	374.8	V	Maximum DC Input Voltage

Input Section

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
Fuse	1.00	A	Input Fuse Rated Current
Iavg	0.16	A	Average Diode Bridge Current (DC Input Current)

Device Variables

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
Device	TNY288PG		PI Device Name
BVDSS	700		Dm-Src Bkdn Voltage
Device Mode	Increased		Current Limit mode for device
PO	11.00	W	Total Output Power
VDRAIN Estimated	604.44	V	Actual Estimated Drain Voltage
VDS	4.45	V	On state Drain to Source Voltage
I2F_MIN	50.19	A ² kHz	Minimum I2F
I2F_MAX	64.69	A ² kHz	Maximum I2F
FS_AT_ILIMMIN	137129	Hz	Switching Frequency at Current Limit Minimum
KP	1.20		Continuous/Discontinuous Operating Ratio
KP_TRANSIENT	1.20		Transient Ripple to Peak Current Ratio
ILIMITMIN	0.60	A	Minimum Current Limit
ILIMITMAX	0.72	A	Maximum Current Limit
IRMS	0.27	A	Primary RMS Current (at VMIN)
DMAX	0.55		Maximum Duty Cycle
RTH_DEVICE	73.78	°C/W	PI Device Maximum Thermal Resistance
DEV_HSINK_TYPE	2 Oz (70 μ) Copper PCB		PI Device Heatsink Type
DEV_HSINK_AREA	52	mm ²	PI Device Heatsink Area

Clamp Circuit

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
Clamp Type	RCD + Zener Clamp		Clamp Circuit Type (Manual Overwrite)
VCLAMP	95	V	Estimated average clamping voltage
Estimated Clamp Loss	0.27	W	Clamp Dissipation

Transformer Construction Parameters

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
Core Type	E20/10/6 (EF20)		Core Type (Manual Overwrite)
Core Material	NC-2H (Nicera) or Equivalent		Core Material
Bobbin Reference	Generic, 5 pri. + 5 sec.		Bobbin Reference
Bobbin Orientation	Horizontal		Bobbin type

Primary Pins	5		Number of Primary pins used
Secondary Pins	5		Number of Secondary pins used
USE_SHIELDS	NO		Use shield Windings
LP_nom	626	μH	Nominal Primary Inductance
LP_Tol	10.0	%	Primary Inductance Tolerance
NP	73.0		Calculated Primary Winding Total Number of Turns
NSM	3		Secondary Main Number of Turns
CMA	476	Cmils/A	Primary Winding Current Capacity
VOR	135.0	V	Reflected Output Voltage
BW	12.50	mm	Bobbin Winding Width
ML	0.00	mm	Safety Margin on Left Width
MR	0.00	mm	Safety Margin on Right Width
FF	71	%	Actual Transformer Fit Factor. 100% signifies fully utilized winding window
AE	32.10	mm ²	Core Cross Sectional Area
ALG	106	nH/T ²	Gapped Core Effective Inductance
BM	1812	Gauss	Maximum Flux Density
BAC	815	Gauss	AC Flux Density for Core Loss
LG	0.350	mm	Estimated Gap Length
L_LKG	18.79	μH	Estimated primary leakage inductance
LSEC	15	nH	Secondary Trace Inductance

Primary Winding Section 1

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
NP1	73		Rounded (Integer) Number of Primary winding turns in the first section of primary
Wire Size	29	AWG	Wire size of primary winding
Winding Type	Single (x1)		Primary winding number of parallel wire strands
L	1.93		Primary Number of Layers
DC Copper Loss	0.05	W	Primary 1 DC Losses

Output 1

<i>Var</i>	<i>Value</i>	<i>Units</i>	<i>Description</i>
VO	5.00	V	Output Voltage
IO	1.00	A	Output Current
VOUT_ACTUAL	5.00	V	Actual Output Voltage
NS	3		Secondary Number of Turns
Wire Size	26	AWG	Wire size of secondary winding
Winding Type	Bifilar (x2)		Output winding number of parallel strands
L_S_OUT	0.29		Secondary Output Winding Layers
DC Copper Loss	0.06	W	Secondary DC Losses
VD	0.55	V	Output Winding Diode Forward Voltage Drop
PIVS	20	V	Output Rectifier Maximum Peak Inverse Voltage
ISP	6.69	A	Peak Secondary Current
SRMS	2.37	A	Secondary RMS Current
RTH_DIODE	96.55	°C/W	Output Diode Maximum Thermal Resistance
OD_HSINK_TYPE	2 Oz (70 μ) Copper PCB		Output Diode Heatsink Type
OD_HSINK_AREA	52	mm ²	Output Diode Heatsink Area

CO	1500 x 1	μF	Output Capacitor
IRIPPLE	2.14	A	Output Capacitor RMS Ripple Current
Expected Lifetime	32118	hr	Expected Lifetime of Output Capacitor

Output 2

Var	Value	Units	Description
VO	5.00	V	Output Voltage
IO	1.00	A	Output Current
VOUT_ACTUAL	5.00	V	Actual Output Voltage
NS	3		Secondary Number of Turns
Wire Size	26	AWG	Wire size of secondary winding
Winding Type	Bifilar (x2)		Output winding number of parallel strands
L_S_OUT	0.29		Secondary Output Winding Layers
DC Copper Loss	0.07	W	Secondary DC Losses
VD	0.55	V	Output Winding Diode Forward Voltage Drop
PIVS	20	V	Output Rectifier Maximum Peak Inverse Voltage
ISP	6.69	A	Peak Secondary Current
ISRMS	2.37	A	Secondary RMS Current
RTH_DIODE	96.55	°C/W	Output Diode Maximum Thermal Resistance
OD_HSINK_TYPE	2 Oz (70 μ) Copper PCB		Output Diode Heatsink Type
OD_HSINK_AREA	52	mm ²	Output Diode Heatsink Area
CO	1500 x 1	μF	Output Capacitor
IRIPPLE	2.14	A	Output Capacitor RMS Ripple Current
Expected Lifetime	32118	hr	Expected Lifetime of Output Capacitor

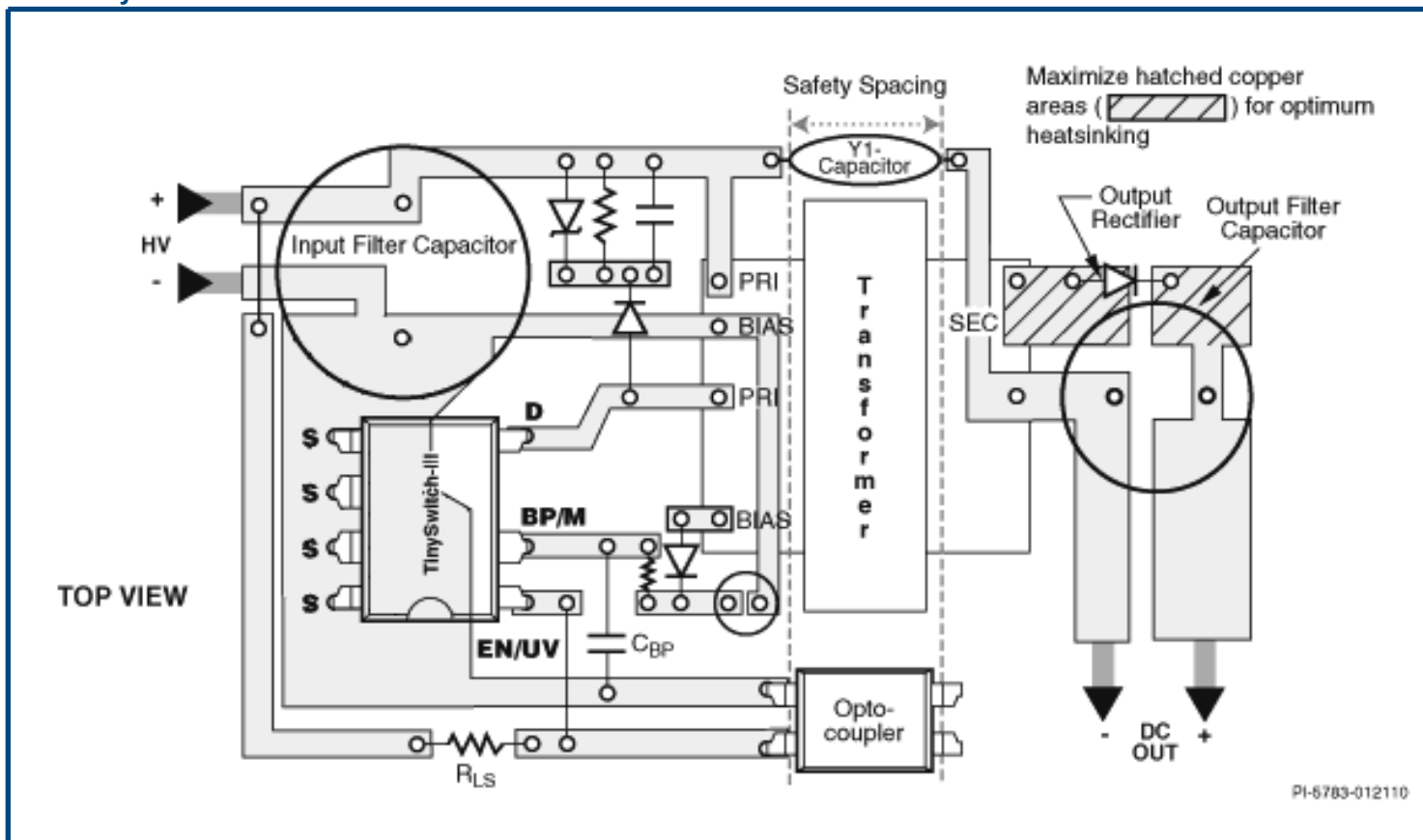
Feedback Circuit

Var	Value	Units	Description
DUAL_OUTPUT_FB_FLAG	NO		Dual Output Feedback regulations use flag
SF_FLAG	NO		Soft Finish Circuits use flag
TYPE_3CTRL_FLAG	NO		Phase Boost Network flag

The regulation and tolerances do not account for thermal drifting and component tolerance of the output diode forward voltage drop and voltage drops across the LC post filter. The actual voltage values are estimated at full load only.

Please verify cross regulation performance on the bench.

Board Layout Recommendations



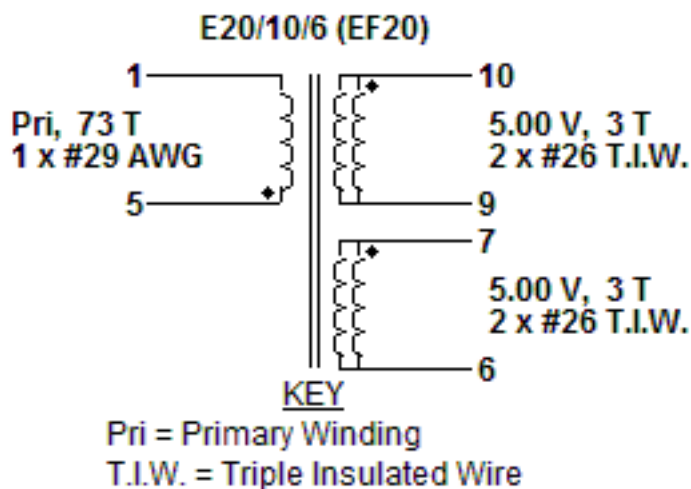
Click on the "Show me" icon to highlight relevant areas on the sample layout.

	Description	Show Me
1	Maximize source area for good heat-sinking	
2	Keep drain trace short	
3	The BYPASS pin capacitor should be located as close as possible to the BYPASS and SOURCE pins	
4	Keep noisy traces away from EN/UV pin	
5	Route bias winding currents back to the bulk cap	
6	Keep clamp loop short	
7	Connect Y capacitor to the B+ rail on the primary side for better surge immunity. Keep Y capacitor traces short	
8	The area of the loop connecting the secondary winding, the output diode and the output filter capacitor should be minimized	

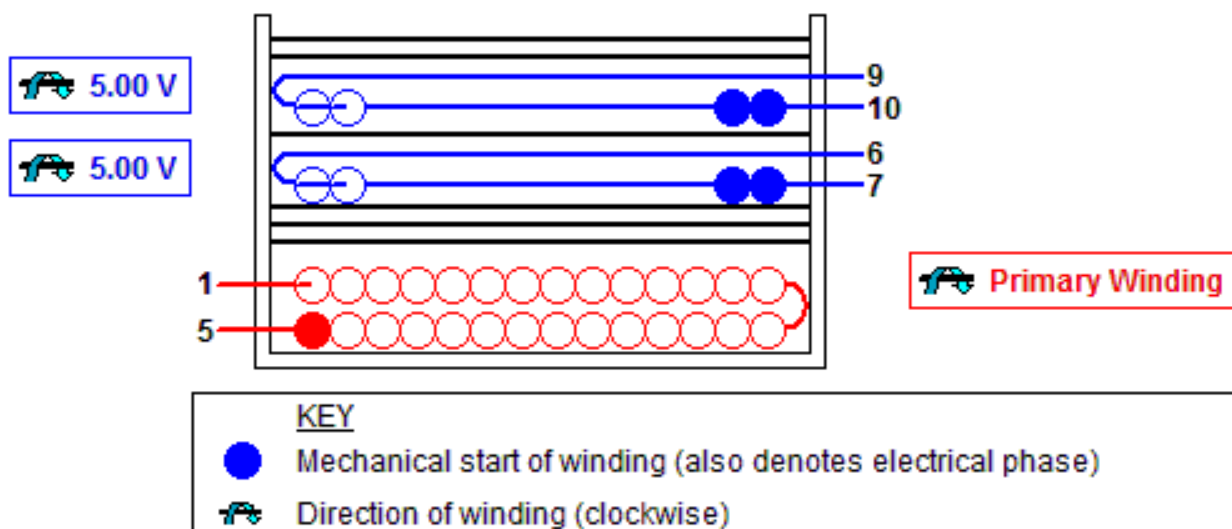
Bill Of Materials

<i>Ite m #</i>	<i>Quantity</i>	<i>Part Ref</i>	<i>Value</i>	<i>Description</i>	<i>Mfg</i>	<i>Mfg Part Number</i>
1	1	C1	22 μ F	22 μ F, 450 V, High Voltage Al Electrolytic, (35 mm x 10 mm)	United Chemi-Con	EPAG450VB22RM10X35LL
2	1	C2	22 μ F	22 μ F, 450 V, High Voltage Al Electrolytic, (25 mm x 16 mm)	United Chemi-Con	EKMX450VB22RM16X25LL
3	1	C3	0.47 nF	0.47 nF, 1 kV, High Voltage Ceramic	NIC Components Corp	NCD471K1KVY5F
4	1	C4	10 μ F	10 μ F, 16 V, Ceramic, X7R	TDK	C3216X7R1C106K
5	1	C5	2.2 nF	2.2 nF, 250 VAC, Ceramic, Y Class	TDK	CD12-E2GA222MYNS
6	2	C6, C7	560 pF	560 pF, 50 V, Ceramic, C0G	TDK	FK18C0G1H561J
7	2	C8, C10	1500 μ F	1500 μ F, 10 V, Electrolytic, Super Low ESR, 22 m Ω , (25 mm x 10 mm)	United Chemi-Con	EKZE100ELL152MJ25S
8	2	C9, C11	100 μ F	100 μ F, 10 V, Electrolytic, Low ESR, 500 m Ω , (11.5 mm x 5 mm)	United Chemi-Con	ELXZ100ELL101MEB5D
9	1	C12	100 nF	100 nF, 16 V, Ceramic, X7R	TDK	C1005X7R1C104K
10	4	D1, D2, D3, D4	1N4007	1000 V, 1 A, Standard Recovery, DO-41	Vishay	1N4007
11	1	D5	1N4937	600 V, 1 A, Fast Recovery, 200 ns, DO-41	Vishay	1N4937
12	2	D6, D7	1N5818	30 V, 1 A, Schottky, DO-41	Vishay	1N5818
13	1	F1	1 A	250 VAC, 1 A, Radial TR5, Time Lag Fuse	Littelfuse / Wickmann(R)	37411000410
14	1	L1	6 mH	6 mH, 1.6 A	Panasonic	ELF18N016
15	2	L2, L3	3.3 μ H	3.3 μ H, 2.66 A	Bourns Inc.	RL822-3R3K-RC
16	1	R1	200 k Ω	200 k Ω , 5 %, 0.5 W, Carbon Film	Generic	
17	1	R2	30 Ω	30 Ω , 5 %, 0.25 W, Carbon Film	Generic	
18	2	R3, R4	2.05 M Ω	2.05 M Ω , 1 %, 0.25 W, Metal Film	Generic	
19	2	R5, R6	18 Ω	18 Ω , 5 %, 0.25 W, Carbon Film	Generic	
20	1	R7	34 Ω	34 Ω , 1 %, 0.125 W, Metal Film	Generic	
21	1	R8	1 k Ω	1 k Ω , 5 %, 0.125 W, Carbon Film	Generic	
22	2	R9, R10	4.99 k Ω	4.99 k Ω , 1 %, 0.125 W, Metal Film	Generic	
23	1	T1	E20/10/6 (EF20)	NC-2H (Nicera) or Equivalent Core Material See Transformer Construction's Materials List for complete information	Epcos	B66311-G-X127
24	1	U1	TNY288PG	TinySwitch-4, TNY288PG, DIP-8	Power Integrations	TNY288PG
25	1	U2	LTV817A	Optocoupler LTV817A, 35 V, CTR 80 - 160 %, 4-DIP	Liteon	LTV817A
26	1	U3	TL431CLPM	2.495 V, Shunt Regulator IC, 2 %, TO-92	Texas Instruments	TL431CLPM
27	1	VR1	P6KE160A	160 V, 5 W, 5 %, DO-204AC, TVS	Vishay	P6KE160A
28	1			52 mm ² area on Copper PCB. 2 oz (70 μ m) thickness. Heatsink for use with Diode D6.	Custom	
29	1			52 mm ² area on Copper PCB. 2 oz (70 μ m) thickness. Heatsink for use with Device U1.	Custom	
30	1			52 mm ² area on Copper PCB. 2 oz (70 μ m) thickness. Heatsink for use with Diode D7.	Custom	

Electrical Diagram



Mechanical Diagram



Winding Instruction

Primary Winding

Start on pin(s) 5 and wind 73 turns (x 1 filar) of item [5], in 2 layer(s) from left to right. At the end of 1st layer, continue to wind the next layer from right to left. On the final layer, spread the winding evenly across entire bobbin. Finish this winding on pin(s) 1.

Add 3 layers of tape, item [3], for insulation.

Secondary Winding

Start on pin(s) 7 and wind 3 turns (x 2 filar) of item [6]. Spread the winding evenly across entire bobbin. Wind in same rotational direction as primary winding. Finish this winding on pin(s) 6.

Add 1 layer of tape, item [3], for insulation.

Start on pin(s) 10 and wind 3 turns (x 2 filar) of item [6]. Spread the winding evenly across entire bobbin. Wind in same rotational direction as primary winding. Finish this winding on pin(s) 9.

Add 2 layers of tape, item [3], for insulation.

Core Assembly

Assemble and secure core halves. Item [1].

Varnish

Dip varnish uniformly in item [4]. Do not vacuum impregnate.

Comments

1. For non margin wound transformers use triple insulated wire for all secondary windings.

Materials

<i>Item</i>	<i>Description</i>
[1]	Core: E20/10/6 (EF20), NC-2H (Nicera) or Equivalent, gapped for ALG of 106 nH/T ²
[2]	Bobbin: Generic, 5 pri. + 5 sec.
[3]	Barrier Tape: Polyester film [1 mil (25 µm) base thickness], 12.50 mm wide
[4]	Varnish
[5]	Magnet Wire: 29 AWG, Solderable Double Coated
[6]	Triple Insulated Wire: 26 AWG

Electrical Test Specifications

<i>Parameter</i>	<i>Condition</i>	<i>Spec</i>
Electrical Strength, VAC	60 Hz 1 second, from pins 1,5 to pins 6,7,9,10.	3000
Nominal Primary Inductance, µH	Measured at 1 V pk-pk, typical switching frequency, between pin 1 to pin 5, with all other Windings open.	626
Tolerance, ±%	Tolerance of Primary Inductance	10.0
Maximum Primary Leakage, µH	Measured between Pin 1 to Pin 5, with all other Windings shorted.	18.79

Although the design of the software considered safety guidelines, it is the user's responsibility to ensure that the user's power supply design meets all applicable safety requirements of user's product.

